

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT										
NATURE OF CONVEYANCE:	Corrective Assignment to correct the nunc pro tunc assignment's effective date and the patent's recited filing date as previously recorded on Reel 026793 Frame 0681. Assignor(s) hereby confirms the nunc pro tunc assignment's effective date is 01/11/2000 and the patent's filing date is 12/23/1999.										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Subhas Bothra</td><td>08/19/2011</td></tr><tr><td>Steven L. Skala</td><td>06/26/2011</td></tr><tr><td>Emmanuel de Muizon</td><td>07/04/2011</td></tr></tbody></table>		Name	Execution Date	Subhas Bothra	08/19/2011	Steven L. Skala	06/26/2011	Emmanuel de Muizon	07/04/2011		
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RECEIVING PARTY DATA											
<table border="1"><tr><td>Name:</td><td>Philips Semiconductors, Inc.</td></tr><tr><td>Street Address:</td><td>1251 Avenue of the Americas</td></tr><tr><td>City:</td><td>New York</td></tr><tr><td>State/Country:</td><td>NEW YORK</td></tr><tr><td>Postal Code:</td><td>10020</td></tr></table>		Name:	Philips Semiconductors, Inc.	Street Address:	1251 Avenue of the Americas	City:	New York	State/Country:	NEW YORK	Postal Code:	10020
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PROPERTY NUMBERS Total: 1											
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Patent Number:	6787908										
CORRESPONDENCE DATA											
Fax Number: (408)518-5671											
Phone: 3474431592											
Email: david.schaeffer@nxp.com											
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>											
Correspondent Name: David L. Schaeffer											
Address Line 1: 411 East Plumeria Drive, MS41											
Address Line 2: NXP Semiconductors, IP&L											
Address Line 4: San Jose, CALIFORNIA 95134											
NAME OF SUBMITTER:	David L. Schaeffer										

CH \$40.00 6787908

501714900

PATENT  
REEL: 027181 FRAME: 0925

Total Attachments: 4

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## PATENT ASSIGNMENT

Electronic Version v1.1  
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08/23/2011  
501635238

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	NUNC PRO TUNC ASSIGNMENT										
EFFECTIVE DATE:	01/11/1999										
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Phone: 3474431592											
Email: david.schaeffer@nxp.com											
Correspondent Name: David L. Schaeffer											
Address Line 1: 1109 McKay Drive, M/S 41 SJ											
Address Line 2: NXP Semiconductors, IP&L											
Address Line 4: San Jose, CALIFORNIA 95131											
NAME OF SUBMITTER:	David L. Schaeffer										
Total Attachments: 3 source=6261939NPTInventorAssigntoPSIExecuted#page1.tif source=6261939NPTInventorAssigntoPSIExecuted#page2.tif source=6261939NPTInventorAssigntoPSIExecuted#page3.tif											

CH 6787908 \$40.00

**NUNC PRO TUNC ASSIGNMENT**

9/30/2011

2000 For good and valuable consideration, receipt of which is hereby acknowledged, I, as <sup>2000</sup> below named Assignor, hereby sell, and assign, and transfer, nunc pro tunc effective January 11, 1999, my entire and exclusive right, title, and interest in the following to Philips Semiconductors, Inc., having a place of business at 1251 Avenue of the Americas, New York, New York 10020, United States, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"):

my/our invention relating to "PAD METALLIZATION OVER ACTIVE CIRCUITRY", for which U.S. Patent No. 6,261,939 was granted on July 17, 2001, (based upon U.S. Patent Application No. 09/472,384, filed on December 29, 1999); and

all rights in and to said patent, and all United States, foreign and international patent applications associated therewith, based thereon, or claiming priority therefrom including, but not limited to, any and all provisionals, non-provisionals, divisions, continuations, continuations-in-part, reexaminations, reissues, and extensions thereof, and the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

I further confirm that, as of January 11, 1999, I had authorized and requested the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to Philips Semiconductors, Inc. for its sole use, and that of its successors, assigns, and legal representatives.

I further confirm that, as of January 11, 1999, I had covenanted and agreed, and continue to covenant and agree to provide my cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, I agreed and agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecutorial actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

I also hereby confirm that, as of January 11, 1999, I had transferred unto the Assignee, its successors, legal representatives and assigns, all claims for damages by reason of past infringement of any patents based in whole or part upon said application, the right to sue for and collect the same for their own use and for the use and enjoyment of their successors, legal representatives or other assigns and do hereby assign and set over unto Assignee, its successors and assigns, nunc pro tunc effective January 11, 1999, all such claims and rights.

I certify that I have the full right to convey the above rights.

8/19/2011  
Date

Subhas Bothra  
Subhas Bothra

Assignor

Date

Steven L. Skala

Assignor

Date

Emmanuel DeMuizon

Assignor

**NUNC PRO TUNC ASSIGNMENT**

10/3/2011

2000 For good and valuable consideration, receipt of which is hereby acknowledged, I, as a below-named Assignor, hereby sell, and assign, and transfer, nunc pro tunc effective January 11, 1999, my entire and exclusive right, title, and interest in the following to Philips Semiconductors, Inc., having a place of business at 1251 Avenue of the Americas, New York, New York 10020, United States, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"):

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Date

Subhas Bothra

Assignor

6/26/2011

Date

Steven L. Skala

Assignor

Date

Emmanuel DeMuizon

Assignor

Eder  
Initials

**NUNC PRO TUNC ASSIGNMENT**

11/5/11

2000 For good and valuable consideration, receipt of which is hereby acknowledged, I, as a Date  
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\_\_\_\_\_  
Date Subhas Bothra Assignor

\_\_\_\_\_  
Date Steven L. Skala Assignor

07/04/2011  
Date Emmanuel DeMuniz Assignor